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Fabrication and nuclear analysis of isotopic $^{14}\text{N}$ and $^{15}\text{N}$ ion-implanted silicon standards

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Abstract

The fabrication of reliable isotopic nitrogen standards is achieved in Si through $^{14}\text{N}$ and $^{15}\text{N}$ ion implantation. $60\text{ keV } ^{14}\text{N}^+ \text{ and } ^{15}\text{N}^+$ ions were implanted at $400\degree\text{C}$ to $\sim60\%$ peak atomic concentration, yielding nitrogen-saturated silicon layers as measured using resonant nuclear reaction analysis. No isotopic effect has been observed. The nitrogen standards are validated by measurements of stability under ion irradiation. No significant desorption of nitrogen is observed either under a $^3\text{He}^+$ ion fluence of $3.36 \times 10^{16}\text{ cm}^{-2}$ or under a $^1\text{H}^+$ ion fluence of $8.60 \times 10^{17}\text{ cm}^{-2}$, giving strong evidence that isotopic nitrogen standards can be achieved.

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1. Introduction

Recent developments in the synthesis of confined and nanostructured materials have involved the use of very sensitive characterization techniques. Resonant nuclear reaction analysis (RNRA) has been recognized as a successful method for the detection of light and/or isotope elements through reaction cross-sections. This technique is attractive since it allows depth profiling and interface analysis, providing non destructive and highly quantitative measurements. For example, hydrogen detection is essential to enable further advancement on multiple applications in nanotechnology and astrophysics, such as the modification of metallic thin-films [1], the fabrication of nano electronic components [2–5] and silicon nanocrystals for integrated optoelectronics [6] and the understanding of nuclear reaction rates in stellar nucleosynthesis [7]. Nitrogen also plays an important role in materials engineering, especially in understanding fundamental properties of nanomaterials [8,9]. For example, the nuclear reactions $^{14}\text{N}(^3\text{He},p)^{16}\text{O}$ and $^{14}\text{N}(^3\text{He},a)^{13}\text{N}$ have been utilized in the profiling of nitrogen in steel [10]. In addition, there is an astrophysical interest in the knowledge of reaction cross-sections under the Coulomb barrier involving, for instance, nitrogen isotopes ($^{14}\text{N}$ and $^{15}\text{N}$). The CNO cycle, first described by Hans Bethe [11], dominates the energy production for stars heavier than two solar masses and is mainly composed of four reactions where a proton is consumed: $^{12}\text{C}(p,\gamma)^{13}\text{N}$, $^{13}\text{C}(p,\gamma)^{14}\text{N}$, $^{14}\text{N}(p,\gamma)^{15}\text{O}$, and $^{15}\text{N}(p,\alpha\gamma)^{12}\text{C}$. The $^{14}\text{N}(p,\gamma)^{15}\text{O}$ reaction has been widely studied, most notably in the detection of outgoing gamma rays from irradiated $^{14}\text{N}$ targets [12–15]. There are many technical advantages of working with a thin target containing $^{14}\text{N}$ or $^{15}\text{N}$ ions compared to a gaseous target. A solid implanted target is more geometrically compact and may contain more than a traditional and bulky gaseous target [15].

The precise measurement of nuclear cross-section requires the use of stable and reliable reference standards of known concentration of the element on which the reaction of interest is produced. Ideally, a standard should exhibit a
flat and thin saturated concentration profile, starting from the very near surface region (i.e. a few tenth of nanometers), while having a high degree of reproducibility. The stability of the standard under ion irradiation is a very important aspect in order to avoid desorption of the elements during non-destructive analysis. Somewhat surprisingly, to our knowledge, the fabrication of isotopic nitrogen standards via ion implantation has not been reported yet. It is thought that compounds of silicon nitrides (Si₃N₄) may have the required properties for achieving standards due to the strong binding of nitrogen atoms to silicon atoms in the lattice structure. Although Si₃N₄ thin-film materials can be fabricated by PECVD, the stoichiometry depends upon the deposition conditions [16,17]. One should note that existing nitrogen standards contain the natural isotopic abundance of nitrogen (99.634% of ¹⁴N and 0.366% of ¹⁵N), which is not ideal for a standard. Fortunately, ion implantation has the ability to perform standard fabrication with different isotopic elements as compared to high-cost isotopic gas in PECVD methods. Moreover, ion implantation allows the production of standard samples containing very high ¹⁵N or ¹⁴N isotope concentrations (close to 100%).

Nitrogen implantation in silicon has been investigated by different research groups and the results reported in literature (see for instance [18–24]). The motivation of most of these works was to create an insulating Si₃N₄ buried layer into Si wafers for microelectronic applications and, therefore, the samples were annealed at high temperature (∼1200 °C) after nitrogen implantation [19–24]. Thus, the microstructure of implanted samples was characterized in order to study the damage induced by the implantation and the recovery following sample annealing. SIMS depth-profiling of N ions implanted in Si was reported [23,24]. These measurements combined to TEM characterization indicated the formation of nitrogen gas bubbles for ion fluences exceeding 1.4 × 10¹⁸ cm⁻² with an implantation energy of 200 keV/atom [24]. However, to our knowledge, only Miyagawa et al. [20] has reported a quantitative depth profiling of nitrogen implanted in silicon. In their work, they also used a dynamic software that simulates the nitrogen depth profile. Calculations indicate that three different implantation energies can produce a flat profile with the Si₃N₄ stoichiometry. But the procedure (molecular or atomic ions, temperature, sequence of the implantations) is not so clear. Also, there has been no study of the retained dose as a function of the nitrogen fluence and no indication concerning the influence of the isotopic species (¹⁴N or ¹⁵N) on the retained dose for different implantation fluences. More, they did not report on the stability of the implanted samples under irradiation. Reproducible and reliable nitrogen depth-profiles and nitrogen stability under irradiation are two key parameters in the production of standards and are of great importance for our applications. For example, in the synthesis of photoluminescent Si-nanocrystals in SiO₂, the use of isotope ¹⁵N and the resonant ¹⁵N(p,γ)¹²C nuclear reaction may permit to distinguish between the role played by the implanted nitrogen (for instance ¹⁵N) and the nitrogen trapped during annealing (¹⁴N) [23–25].

In this paper, we report on the fabrication and characterization of nitrogen standards in ¹⁴N₂⁺ and ¹⁵N₂⁺ ion implanted silicon wafers with a simple and reproducible procedure. A single energy implantation was carried out at high temperature and high fluence to allow redistribution of introduced atoms in excess of the solubility limit. The need for stable and reliable isotopic nitrogen standards is then required for precise measurements of nitrogen composition through nuclear cross-section measurements. High purity silicon nitride compounds of ¹⁴N and ¹⁵N having high stability under ion irradiation may indicate the synthesis of potentially new nitrogen standards in Si samples. Our experiments can also give some insights on a possible isotopic effect on the retained dose. Simulation by means of SRIM-2006 [26] indicates that although the ion depth profiles are very similar for both isotopes (because their respective velocities are close), the sputtering yield of Si is somewhat larger with the ¹⁵N isotope. For instance, according to SRIM-2006, with an ion energy of 30 keV/atom, the sputtering yields are 0.84 and 0.88 for ¹⁴N and ¹⁵N, respectively, while the values for ion range, straggle, skewness and kurtosis are 83.7 nm, 32.7 nm, 0.16 and 0.63 for ¹⁴N and 84.6 nm, 32.5 nm, 13.7 and −93.5 for ¹⁵N. Simulations suggest that a larger N concentration could be obtained with the ¹⁴N isotope.

2. Experimental

The ¹⁴N₂⁺ and ¹⁵N₂⁺ ion implanted Si samples were prepared from commercially purchased single crystal Si(100) wafers with an electronic grade surface finish. They were first cleaned in dilute HF for 5 min to remove the native oxide on the surface prior to implantation. The ion implantation was performed by means of two ion implanters equipped with magnetic mass selection stages. In the first experiment, the ¹⁴N₂⁺ ions extracted from a Freeman source were implanted at an energy of 60 keV with a uniform large-area beam scanning. In the second set of experiments, the ¹⁵N₂⁺ ion implantations were performed using an RF ion source mounted on a SAMES 150 kV accelerator. The extracted 60 keV ¹⁵N₂⁺ beam were uniformly scanned in both axes through the application of triangular shape electric fields. Both sets of implantation were performed at room temperature but we have estimated that the incoming ion impact (∼3.5 μA/cm²) has raised the surface temperature to a maximum of ∼200 °C.

First, specimens were implanted with fluences in the range (1–10⁶) × 10¹⁸ atoms/cm² in order to obtain the saturation dose. Then, we implanted other samples to a dose of 1.06 × 10¹⁸ atoms/cm² at ∼400 °C to promote a broad and nearly homogeneous distribution of the implanted nitrogen thanks to thermal diffusion of nitrogen atoms present in excess in the layer. Finally, it is worth mentioning that both implanters allow very good mass separation and fluence control.
The implanted nitrogen profiles were measured using resonant nuclear reaction analysis (RNRA), namely the most used $^{14}$N$(\alpha,c) ^{18}$F and $^{15}$N$(p,ac) ^{12}$C nuclear reaction showing resonances at 1.531 MeV [27] and 0.429 MeV [28], respectively. Both reactions were extensively studied in a previous work [29]. The advantage of RNRA is the narrow and intense resonance exhibited by the cross-section leading, to an excellent depth resolution of the nitrogen profiles [7,29,31]. The reported values for the $^{15}$N$(p,ac) ^{12}$C resonances are 0.12 keV [28] and 1.56 b [30] for the width and the cross section, respectively. Concerning the $^{14}$N$(\alpha,c) ^{18}$F resonance, Gossett mentions a width of 0.6 keV [27] and we deduce from this value and the resonance strength of 2.6 eV [32] a resonant cross section of 3.1 mb. All RNRA measurements were done with the ALTAIS, the linear accelerator installed at LARN. It is a tandemron with 2 MV terminal high voltage, which allows acceleration of nearly all negative ions produced either through a source of negative ions by cesium sputtering (SNICS) or by a duoplasmatron gas source. The experimental set-up is described in more details elsewhere [7]. The $^{14}$N and $^{15}$N depth profiles are measured by varying step by step the incident $^{4}$He$^+$ and proton energy, so that the resonant cross section acts as a probe in the implanted nitrogen depth distribution. At each energy, gamma rays of 4.44 MeV produced by de-excitation of the $^{12}$C nuclei for the $^{15}$N profile and gamma rays in the range of 3.06–5.60 MeV produced by de-excitation of the $^{18}$F nuclei for the $^{14}$N profile were counted in a NaI(Tl) well detector.

The stability of standards is a main issue since compounds composition may change under an analyzing beam. The RNRA technique was then used as a probe to study the nitrogen depletion from the implanted layer in standards. The stability of $^{14}$N and $^{15}$N standards under ion beam was performed with a 200 nA beam current of 1.546 MeV $^{4}$He$^+$ ions and 250 nA beam current of 0.435 MeV $^{1}$H$^+$ ions, respectively. The total integrated charge was obtained with a Faraday cup placed in the well detector. The beam shape was circular with a diameter of 1 mm and 4 mm for $^{1}$H$^+$ and $^{4}$He$^+$ beams, respectively. Then, the total ion fluences ($3.36 \times 10^{16}$He$^+$/cm$^2$ and $8.60 \times 10^{17}$H$^+$/cm$^2$) were calculated using the integrated ion charge of incident particles and the ion beam diameter. The acquisition software used in these measurements allows the counting of emitted gamma rays for a given charge range, continuously during data collection. Thus, any nitrogen desorption could be observed.

3. Results and discussion

Fig. 1 shows some depth profiles of the first set of implantations. It is visible that for high fluences the concentration exceeds Si$_3$N$_4$ composition, as predicted in [20]. Ions ranges and stragglers for these depth profiles are given in Table 1. Both ion range and straggle increase with the ion fluence. Thus, it seems that the ion induced damage, which profile is nearer to the surface than the ion depth profile (according to SRIM-2006 simulation), does not promote ion trapping. The Fig. 2 shows the retained implanted

![Fig. 1. Nitrogen depth profiles of some samples implanted in silicon with 60 keV N$^+$ at different fluences. The nitrogen concentration in Si$_3$N$_4$ compounds is shown.](image1)

![Fig. 2. Retained dose of $^{14}$N and $^{15}$N standards as a function of the incident nitrogen fluence. These values were obtained by integrating all nitrogen depth profiles.](image2)
nitrogen ($^{14}$N and $^{15}$N) doses as a function of the incident fluence, which is defined as the number of nitrogen incident atoms. The values were obtained by integrating all the RNRA depth profiles of the implanted species. At fluences lower than $5.5 \times 10^{17}$ N/cm$^2$, the retained dose increases linearly with a coefficient close to 1. The saturation is reached for each isotope at a fluence of $\sim 6.0 \times 10^{17}$ N/cm$^2$, confirming that a given amount of the implanted nitrogen has not been retained in the silicon lattice. It is worth mentioning that both the ion range and the straggle (Table 1) strongly increase with fluences around $\sim 5.0 \times 10^{16}$ N/cm$^2$ to reach 119.5 nm and 71.7 nm at the high fluence of $1.06 \times 10^{18}$ N/cm$^2$, respectively. Kilner et al. [24] reported the formation of N gas bubbles for ion fluences larger than $1.4 \times 10^{17}$ cm$^{-2}$ (200 keV) that correspond to an ion fluence of $\sim 6.0 \times 10^{17}$ cm$^{-2}$ for an energy of 30 keV/atom. Thus, the N concentration saturation would correspond to the beginning of N gas bubble formation. The release of gas trapped in these bubbles [33] could explain the fluctuation in the retained dose observed for fluences larger than $6.0 \times 10^{17}$ cm$^{-2}$.

The saturation of the nitrogen retained dose could be explained by three different processes. First, the backscattering of ions by the silicon matrix has been calculated by SRIM [26] simulation and is very low ($\sim 1.4\%$). Secondly, the sputtering of the target should be taken into account for the two species contained in the target. At first, incident nitrogen ions sputter only silicon, but implanted nitrogen is also rapidly sputtered. On the opposite, swelling will contribute to increase the nitrogen retention, especially at high fluences, in increasing the implantation layer thickness. Using the results of SRIM simulation and a reasonable swelling, one can calculate that backscattering and sputtering alone cannot explain a saturation of the retained N doses for fluences larger than $6.0 \times 10^{17}$ cm$^{-2}$, although these two phenomena could explain that the retained dose increases with a coefficient slightly lower than 1. Nevertheless, SRIM is a static code and this evolution does not appear in the calculations. Thus, another process influences the nitrogen retention. This process could be the thermal diffusion and desorption during the implantation. The diffusion would be strongly enhanced when the local saturation concentration is reached. If it is the case, no isotopic effect can be easily observed. Indeed, with the precision of our measurements, we cannot conclude that an isotopic effect influences the depth profile of $^{14}$N and $^{15}$N implanted in silicon. Same properties have already been observed for nitrogen implantation into iron [29].

RNRA nitrogen depth profiles of 60 keV $^{14}$N$^+$ and $^{15}$N$^+$ ion implanted silicon at a fluence of $10.6 \times 10^{17}$ N$/\text{cm}^2$ at 400 °C are shown in Fig. 3. The $^{14}$N (Fig. 3(a)) and $^{15}$N (Fig. 3(b)) saturated profiles were measured through $^{14}$N(x,$\gamma$)$^{18}$F at 1.531 MeV and $^{15}$N(p,$\gamma$)$^{12}$C at 0.429 MeV resonant nuclear reactions, respectively. In both cases, a saturation in the nitrogen distribution with a concentration reaching ~60 at.% has been obtained. A retained ion dose of $\sim 6.0 \times 10^{17}$ N$/\text{cm}^2$ has been measured in both cases. The broad spreading of the saturated profiles is due to thermal diffusion effects, which usually occur from high-dose implantations at elevated temperature [34]. We can note that $6.0 \times 10^{17}$ N$/\text{cm}^2$ corresponds to the values used with gaseous targets for nuclear astrophysics cross sections measurements. Finally, the reproducibility of the nitrogen depth profiles has also been observed on two samples implanted in the same conditions.

The composition and structural properties must be controlled in order to ensure a reliable standard. The stability of the $^{14}$N standard under 200 nA beam current of 1.546 MeV $^4$He$^+$ ions and the $^{15}$N standard under 250 nA beam current of 0.435 MeV $^4$He$^+$ ions may be observed in Fig. 3. The number of detected gamma rays, normalized to one nanoCoulomb of incoming ions, gives the evolution of the nitrogen concentration for different irradiating ion fluences. It appears that with irradiation fluence up to $\sim 3.36 \times 10^{16}$ $^4$He/cm$^2$ and to $\sim 8.60 \times 10^{17}$ $^4$He/cm$^2$, the implanted nitrogen profiles remain unchanged.
4. Conclusions

The fabrication of reliable isotopic nitrogen standards has been achieved in $^{14}\text{N}^+$ and $^{15}\text{N}^+$ ion implanted Si at 400 °C to a fluence of $10.6 \times 10^{17} \text{N/cm}^2$. The RNRA and stability data indicate the formation of standards with a high degree of reproducibility. The composition of the implanted Si layers is not affected under ion irradiation suggesting that the stability is maintained. No isotopic effect ($^{14}\text{N}$ versus $^{15}\text{N}$) has been observed, which is in agreement with the fact that thermal diffusion and desorption during the implantation should contribute to the saturation of N retained dose at large ion fluences. The results demonstrate the possibility of using ion implantation in the fabrication of isotopic nitrogen standards, furthering the potential for precise measurements of nuclear cross sections, in particular, for reactions with astrophysical interest involving both nitrogen isotopes ($^{14}\text{N}$ and $^{15}\text{N}$). Indeed, the nitrogen standards obtained in this work present the typical number of atoms used with gaseous target in those cross section measurements.

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